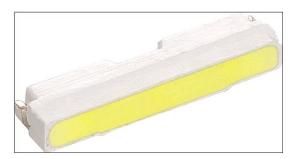


DATASHEET

SMD • Side View LEDs EAPL4210A0



Features

.Side view white LED. .White SMT package. .Lead frame package with individual 2 pins. .Wide viewing angle .Soldering methods: IR reflow soldering .Pb-free .The product itself will remain within RoHS compliant version. .Compliance with EU REACH. .Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

Due to the package design, EAPL4210A0 has wide viewing angle, low power consumption and white LEDs are devices which are materialized by combing blue chips and special phosphor. This feature makes the LED ideal for light guide application.

Applications

Mobile phones.
Indicators.
Illuminations.
Switch lights.

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Device Selection Guide

Chip	 Emitted Color 	Resin Color	
Material		Resili Coloi	
InGaN	Pure White	Water Clear	

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	lF	30	mA
Peak Forward Current (Duty 1/10 @10ms)	I _{FP}	60	mA
Power Dissipation	Pd	110	mW
Operating Temperature	T _{opr}	-40 ~ +85	
Storage Temperature	T _{stg}	-40 ~ +90	
Soldering Temperature	T _{sol}	Reflow Soldering : 260 Hand Soldering : 350	for 10 sec. for 3 sec.

Notes: *1The products are sensitive to static electricity and must be carefully taken when handling products.

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Issue No: DSE-0013881

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Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux		14.00		16.00	lm	
Viewing Angle	2 1/2		120		deg	I _F =20mA
Forward Voltage	V _F	5.40		6.20	V	-
Reverse Current	I _R			50	μA	V _R =5V

Notes:

1. Tolerance of Luminous Flux: ± 7%

2. Tolerance of Forward Voltage: ± 0.05V

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Issue No: DSE-0013881

Revision : 1 LifecyclePhase: 正式發行 Approved

Bin Range of Luminous Flux

Bin Code	Min.	Max.	Unit	Condition
V40	14.00	14.50		
V45	14.50	15.00		I- 20m A
V50	15.00	15.50	– Im	l _F =20mA
V55	15.50	16.00		

Note: Tolerance of Luminous Flux: ± 7%

Bin Range of Forward Voltage

Bin Code	Min.	Max.	Unit	Conditio
S6	5.4	5.6		
S7	5.6	5.8	- V	I _F =20mA
S8	5.8	6.0	V	I _F =20IIIA
S9	6.0	6.2		

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Issue No: DSE-0013881

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Chromaticity	Coordinates	of Bin	Code
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Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
	0.2850	0.2670		0.2893	0.2743
NA0-4-1 —	0.2820	0.2720		0.2865	0.2795
	0.2865	0.2795	- NA0-4-2 -	0.2910	0.2870
	0.2893	0.2743		0.2935	0.2815
	0.2880 0.2620		0.2920	0.2690	
NA0-4-3 -	0.2850	0.2670	– NA0-4-4 –	0.2893	0.2743
	0.2893	0.2743	- NAU-4-4 -	0.2935	0.2815
	0.2920	0.2690		0.2960	0.2760
	0.2935	0.2815		0.2975	0.2885
	0.2910	0.2870		0.2950	0.2940
NB5-3-1	0.2950	0.2940	- NB5-3-2 -	0.2990	0.3010
	0.2975	0.2885		0.3015	0.2955
	0.2960	0.2760		0.3000	0.2830
NB5-3-3	0.2935	0.2815		0.2975	0.2885
	0.2975	0.2885	- NB5-3-4 -	0.3015	0.2955
	0.3000	0.2830		0.3040	0.2900

Note: Tolerance of Chromaticity Coordinates: ±0.01

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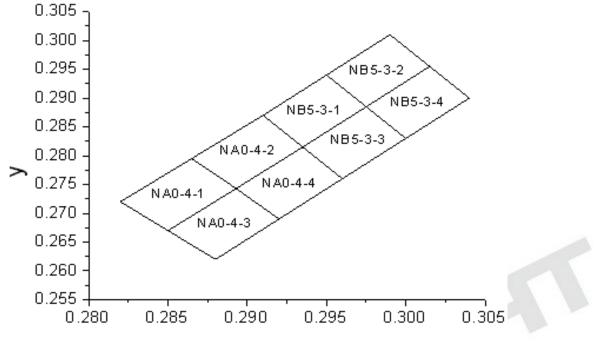
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The C.I.E. 1931 Chromaticity Diagram



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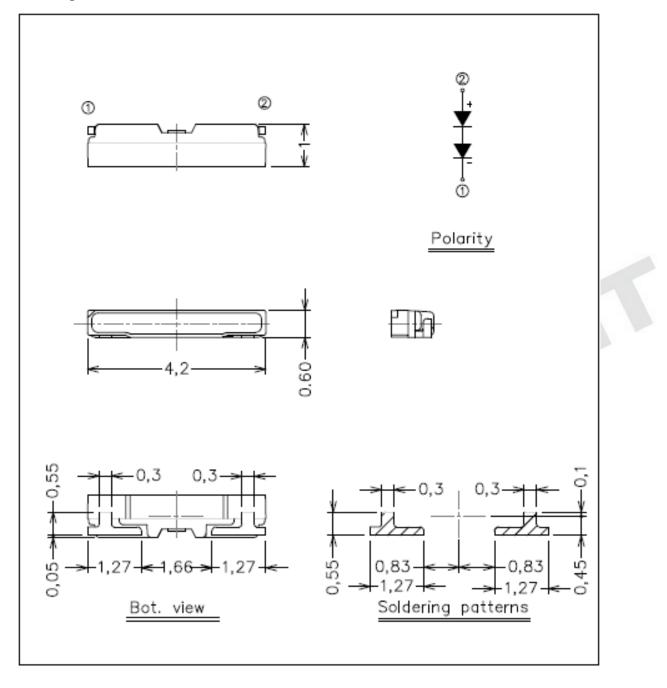
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Revision : 1 LifecyclePhase: 正式發行 Approved



Package Outline Dimensions



Note:

The tolerances unless mentioned is ± 0.1 mm, Unit = mm.

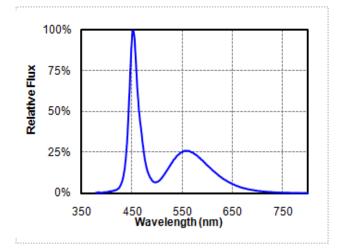




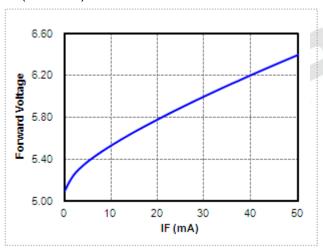
Typical Electro-Optical Characteristics Curves

1. Spectrum Distribution

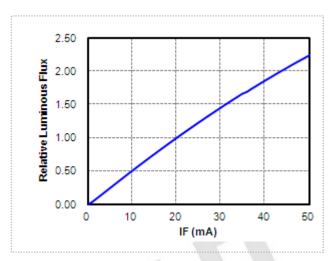
(T_A=25 , I_F=20mA)



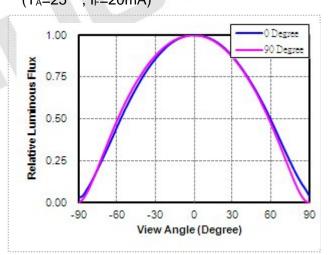
3. Relative Forward Voltage vs. Forward Current $(T_A=25)$



2. Relative Luminous Flux vs. Forward Current $(T_A=25)$



4. Radiation Diagram (T_A=25 , I_F=20mA)



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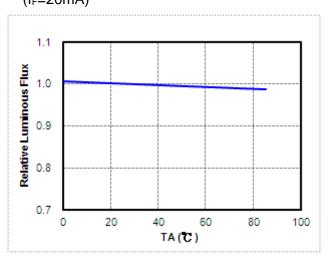
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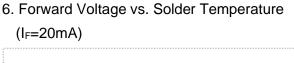
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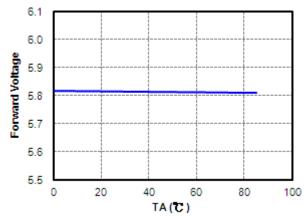


Typical Electro-Optical-Thermal Characteristics Curves

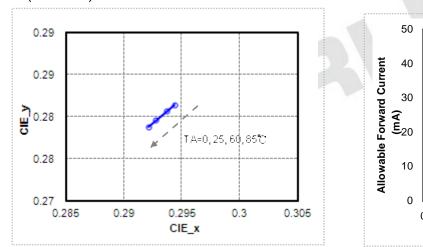
5. Relative Luminous Flux vs. Solder Temperature (I_F=20mA)

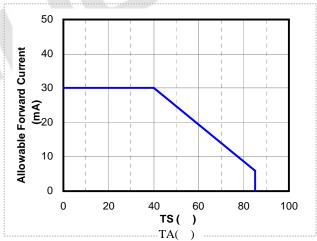






7. Chromaticity Coordinates vs. Solder Temperature 8. Forward Current De-rating Curve (I_F=20mA)





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Issue No: DSE-0013881

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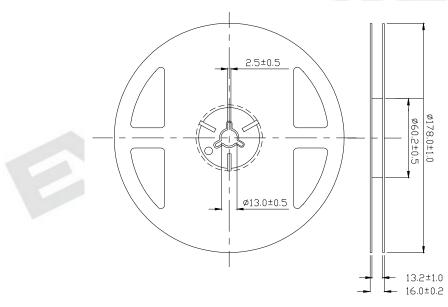


Label Explanation

CAT: Luminous Flux Rank HUE: Chromaticity Coordinates REF: Forward Voltage Rank



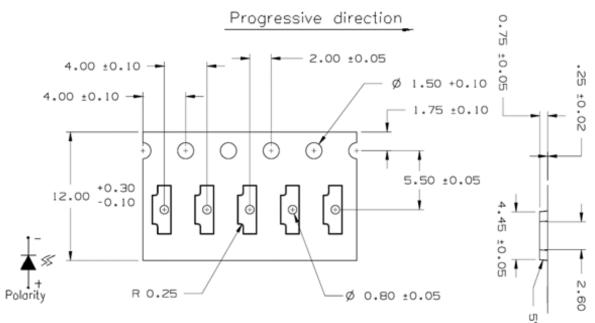
Reel Dimensions



Note: The tolerance unless mentioned is ± 0.1 mm, unit = mm.



Carrier Tape Dimensions: Loaded Quantity 250 up/500/1000/2000 pcs. Per Reel

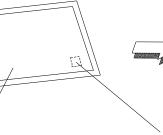


Note: The tolerances unless mentioned is ±0.1mm,Unit = mm.

Moisture Resistant Packaging









Label

Aluminum moisture-proof bag

Desiccant

Label

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Issue No: DSE-0013881

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Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD: 10%

	ltore	Test Conditio	Test Hours		eria	
NO	Item	Temp./ Humidity	l _F (mA)	/ Times	lv @ 20mA	V _F @ 20mA
1	Reflow Soldering	TSId = 260 ,Max.	10sec.	2 times	<±5%	<±5%
2	Temperature Cycle		00 30min.	200 cycles		
3	Thermal Shock	-10 ~ 1 20min. (<15sec.)	00 20min.	200 cycles		
4	Low Temp. Storage	Ta= -40		1000 hrs		
5	High Temp. Storage	Ta= 100		1000 hrs		
6	Temp. Humidity Storage	Ta= 60 / 90%RH		1000 hrs	lv > '	70%,
7	Steady State Operating Life of Low Temp.	Ta= -40	20	1000 hrs	VF < 7	
8	Steady State Operating Life Condition 1	Ta= 25 / Room Humidity	20	1000 hrs		
9	Steady State Operating Life Condition 2	Ta= 60	20	1000 hrs		
10	Steady State Operating Life of High Temp.	Ta= 85	5	1000 hrs		
11	Steady State Operating Life of High Humidity Heat	Ta= 60 / 90%RH	20	1000 hrs		

Notes:

1. Sampling for each test item: 22 (pcs.)

2. Test board: PCB board thickness=1.0mm, copper layer thickness=0.07mm, Rth j-a 380 /W.

3. Measurements are performed after allowing the LEDs to return to room temperature.



Revision : 1 LifecyclePhase: Approved

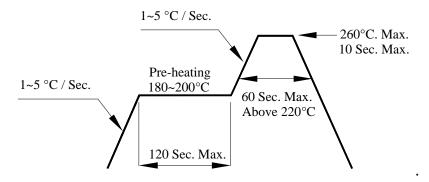


Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Soldering Condition



- 2.1 Pb-free solder temperature profile
- 2.2 Reflow soldering should not be done more than two times.
- 2.3 When soldering, do not put stress on the LEDs during heating.
- 2.4 After soldering, do not warp the circuit board.
- 3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals,

and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

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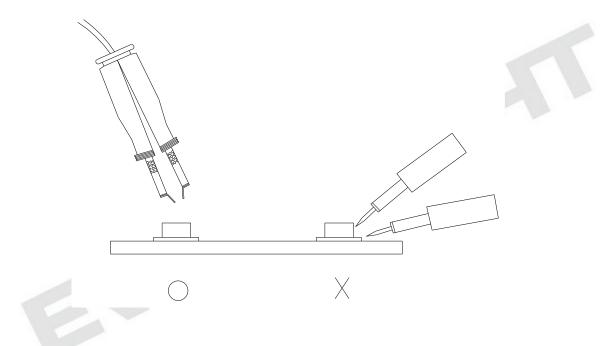
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Revision :1 LifecyclePhase: 正式發行

Issue No: DSE-0013881



- 5. Storage
- 5.1 Do not open moisture proof bag before the products are ready to use.
- 5.2 Before opening the package: The LEDs should be used within one year and kept at 30 or less and 70%RH or less.
- 5.3 After opening the package: We recommend that the LED should be soldered quickly (within 3 days). The soldering condition is 30 or less and 60%RH or less. If unused LEDs remain, it should be stored in moisture proof.
- 5.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment: 60±5 for 24 hours. (One time only)



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible.

Sharp objects of all types should not be used to pierce the sealing compound.

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Issue No: DSE-0013881

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